

High temperature 20 A Snubberless™ TRIACs

Features

- Medium current TRIAC
- 150 °C max. T_j turn-off commutation
- Low thermal resistance with clip bonding
- Very high 3 quadrant commutation capability
- Packages are RoHS (2002/95/EC) compliant

Applications

Especially designed to operate in high power density or universal motor applications such as vacuum cleaner and washing machine drum motor.

Description

Available in through-hole and surface mount packages, the T2035H and T2050H TRIAC series are suitable for general purpose mains power AC switching.

These 20 A TRIACs provide a very high switching capability up to junction temperatures of 150 °C.

The heatsink can be reduced, compared to traditional TRIACs, according to the high performance at given junction temperatures.

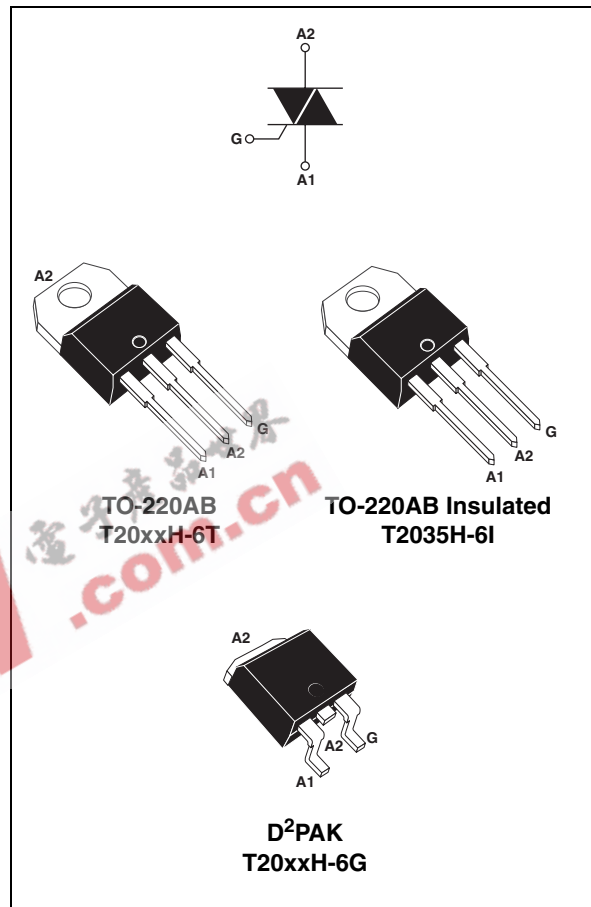


Table 1. Device summary

Symbol	Value	Unit
$I_{T(RMS)}$	20	A
V_{DRM}/V_{RRM}	600	V
I_{GT}	35 or 50	mA

TM: Snubberless is a trademark of STMicroelectronics

1 Characteristics

Table 2. Absolute maximum ratings

Symbol	Parameter		Value	Unit	
$I_{T(RMS)}$	On-state rms current (full sine wave)	TO-220AB, D ² PAK	$T_c = 130\text{ °C}$	20	A
		TO-220AB Ins	$T_c = 105\text{ °C}$		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C)	F = 50 Hz	t = 20 ms	200	A
		F = 60 Hz	t = 16.7 ms	210	
I^2t	I^2t Value for fusing	$t_p = 10\text{ ms}$		265	A ² s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100\text{ ns}$	F = 120 Hz	$T_j = 150\text{ °C}$	50	A/ μ s
V_{DSM}/V_{RSM}	Non repetitive surge peak off-state voltage	$t_p = 10\text{ ms}$	$T_j = 25\text{ °C}$	$V_{DRM}/V_{RRM} + 100$	V
I_{GM}	Peak gate current	$t_p = 20\text{ }\mu$ s	$T_j = 150\text{ °C}$	4	A
$P_{G(AV)}$	Average gate power dissipation	$T_j = 150\text{ °C}$		1	W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 150	°C

Table 3. Electrical characteristics ($T_j = 25\text{ °C}$, unless otherwise specified)

Symbol	Test Conditions	Quadrant	Value		Unit	
			T2035H	T2050H		
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$ $R_L = 33\text{ }\Omega$	I - II - III	MAX.	35	50	mA
V_{GT}		I - II - III	MAX.	1.0		V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3\text{ k}\Omega$	I - II - III	MIN.	0.15		V
$I_H^{(2)}$	$I_T = 500\text{ mA}$		MAX.	35	75	mA
I_L	$I_G = 1.2 I_{GT}$	I - III	MAX.	50	90	mA
		II		80	110	
dV/dt ⁽²⁾	$V_D = 67\% V_{DRM}$, gate open, $T_j = 150\text{ °C}$		MIN.	1000	1500	V/ μ s
(dI/dt) _c ⁽²⁾	Without snubber, $T_j = 150\text{ °C}$		MIN.	27	36	A/ms

1. minimum I_{GT} is guaranteed at 20% of I_{GT} max.
2. for both polarities of A2 referenced to A1.

Table 4. Static characteristics

Symbol	Test Conditions		Value	Unit	
$V_T^{(1)}$	$I_{TM} = 28\text{ A}$, $t_p = 380\ \mu\text{s}$	$T_j = 25\ ^\circ\text{C}$	MAX.	1.5	V
$V_{i0}^{(1)}$	Threshold voltage	$T_j = 150\ ^\circ\text{C}$	MAX.	0.80	V
$R_d^{(1)}$	Dynamic resistance	$T_j = 150\ ^\circ\text{C}$	MAX.	19	m Ω
I_{DRM} $I_{RRM}^{(2)}$	$V_{DRM} = V_{RRM}$	$T_j = 25\ ^\circ\text{C}$	MAX.	5	μA
		$T_j = 150\ ^\circ\text{C}$	MAX.	6.2	mA
	$V_D/V_R = 400\text{ V}$ (at peak mains voltage)	$T_j = 150\ ^\circ\text{C}$	MAX.	5.0	
	$V_D/V_R = 200\text{ V}$ (at peak mains voltage)	$T_j = 150\ ^\circ\text{C}$	MAX.	4.0	

- for both polarities of A2 referenced to A1.
- $t_p = 380\ \mu\text{s}$.

Table 5. Thermal resistance

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	TO-220AB, D ² PAK	1	$^\circ\text{C/W}$
		TO-220AB Ins	1.9	
$R_{th(j-a)}$	Junction to ambient	TO-220AB, TO-220AB Ins	60	
		$S = 1\ \text{cm}^2$ D ² PAK	45	

Figure 1. Maximum power dissipation versus on-state rms current **Figure 2. On-state rms current versus case temperature**

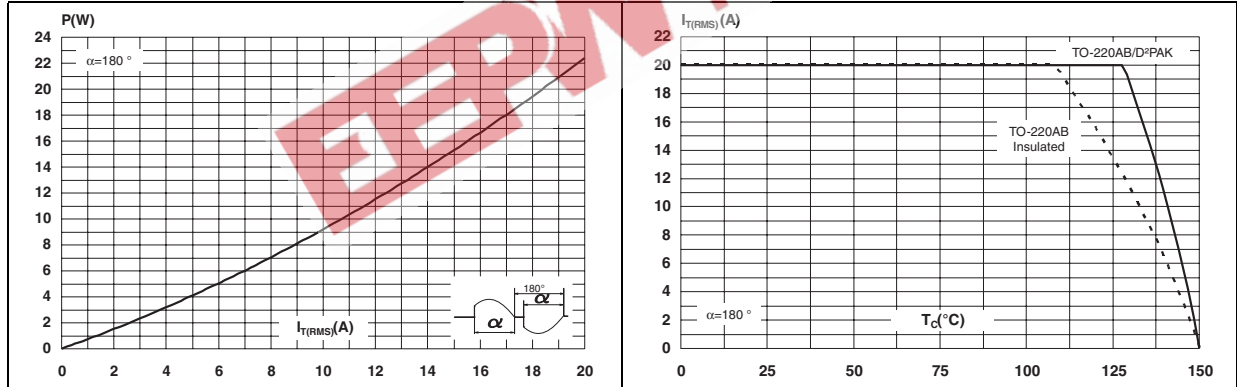


Figure 3. On-state rms current versus ambient temperature

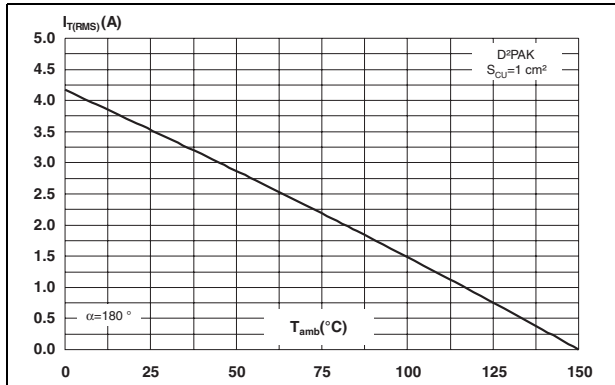


Figure 4. Variation of thermal impedance versus pulse duration

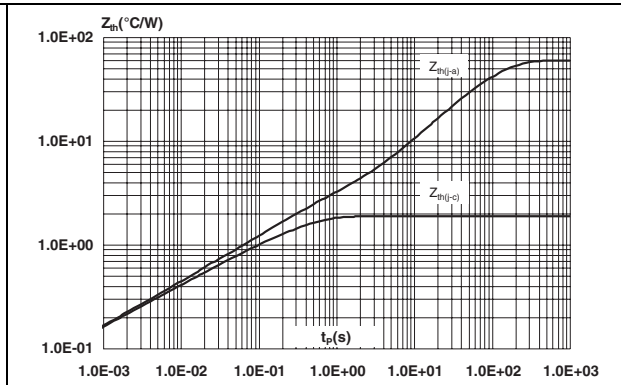


Figure 5. On-state characteristics (maximum values)

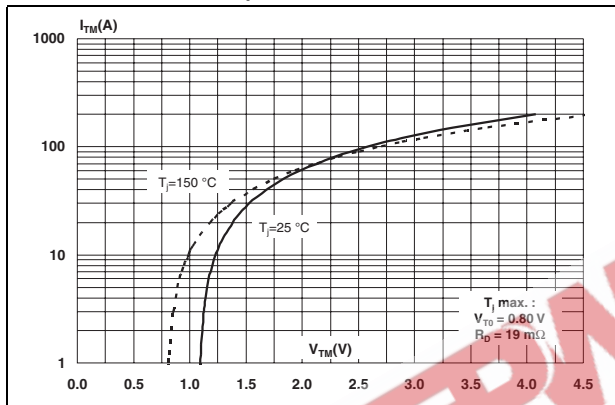


Figure 6. Surge peak on-state current versus number of cycles

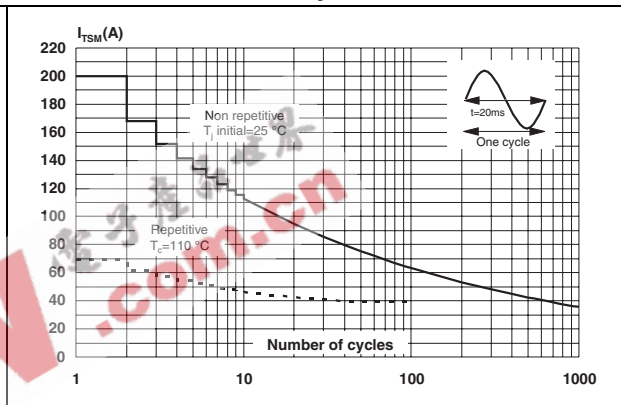


Figure 7. Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10$ ms and corresponding value of I^2t

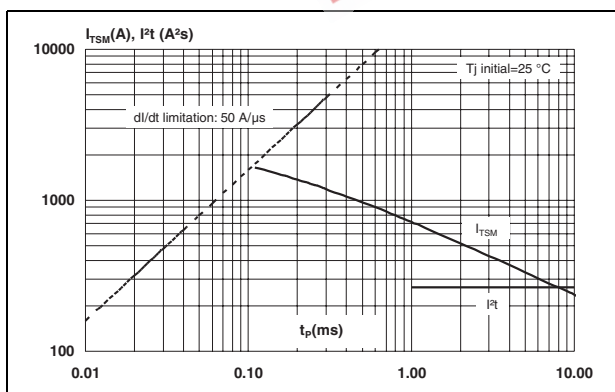


Figure 8. Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

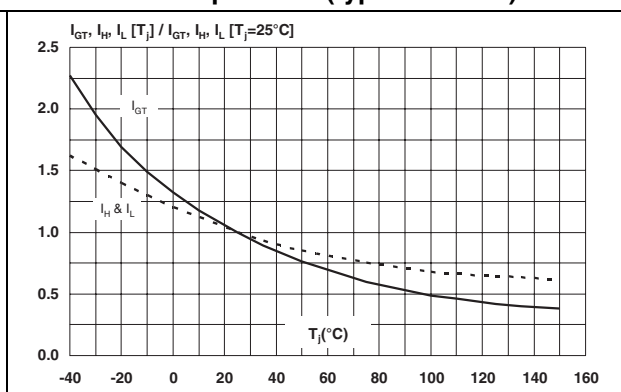


Figure 9. Relative variation of critical rate of decrease of main current (dl/dt)_c versus reapplied (dV/dt)_c (typical values)

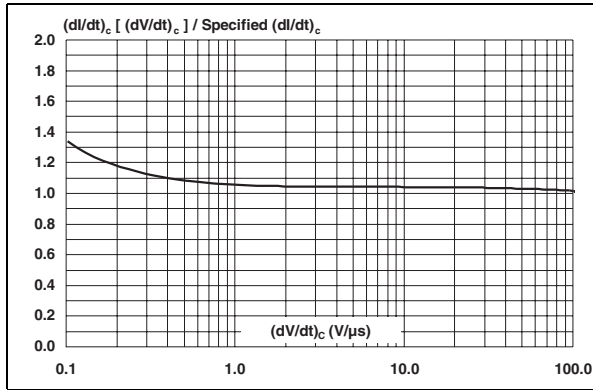


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature

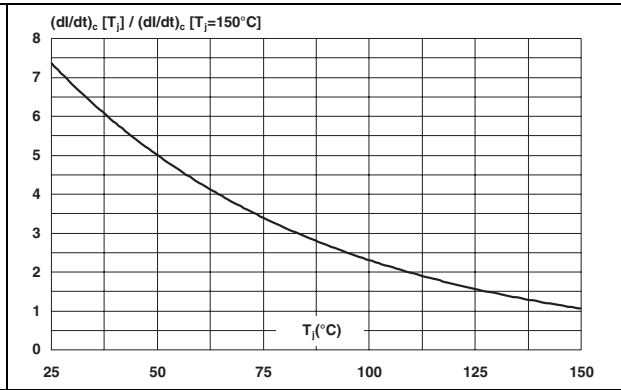


Figure 11. Leakage current versus junction temperature for different values of blocking voltage (typical values)

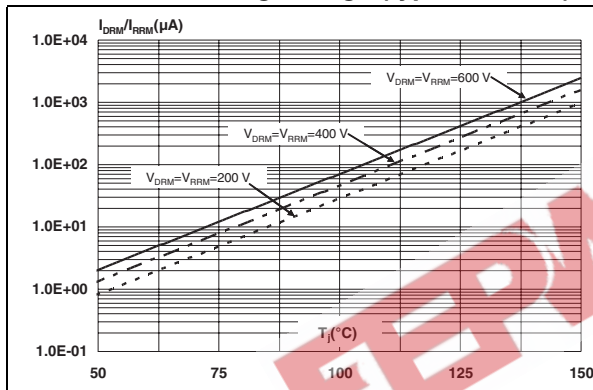


Figure 12. Acceptable repetitive peak off-state voltage versus case to ambient thermal resistance

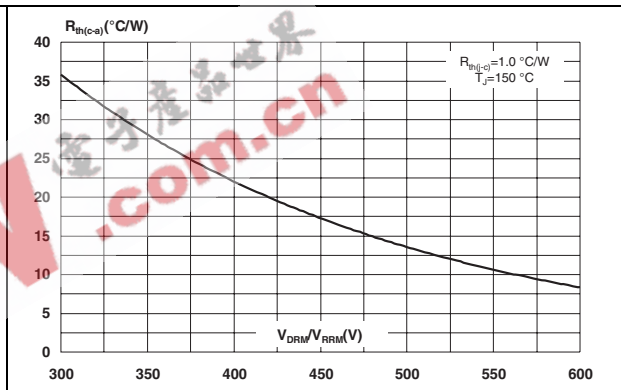
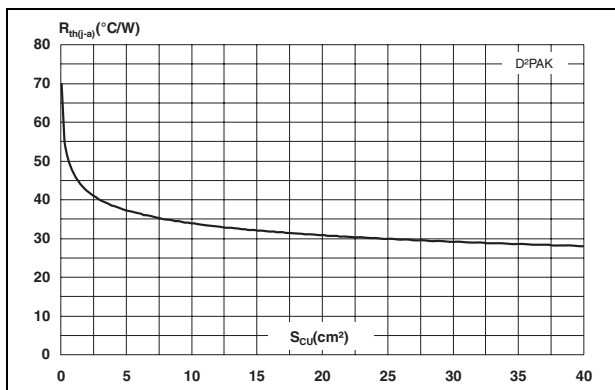
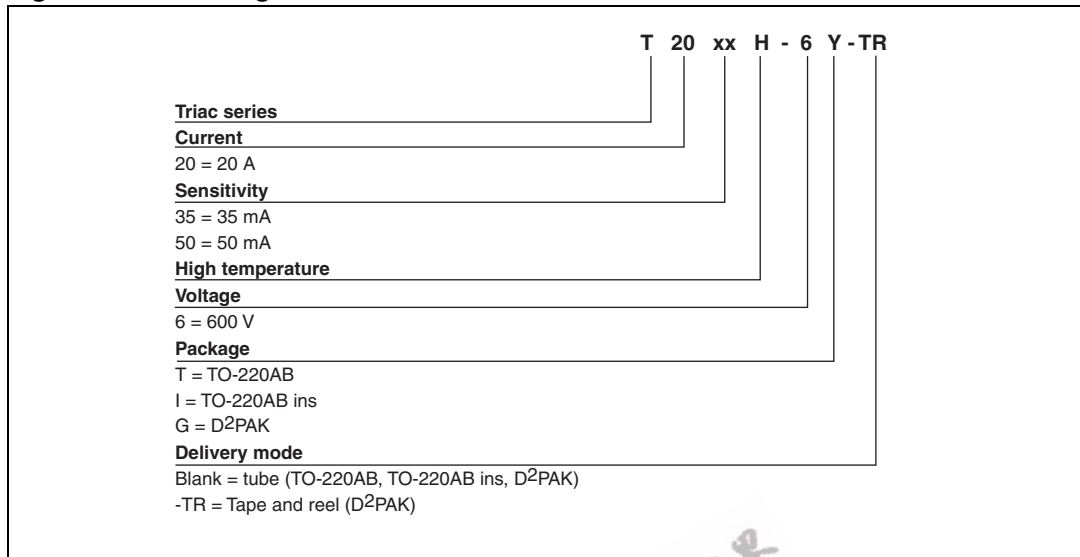


Figure 13. Thermal resistance junction to ambient versus copper surface under tab



2 Ordering information

Figure 14. Ordering information



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3 Package information

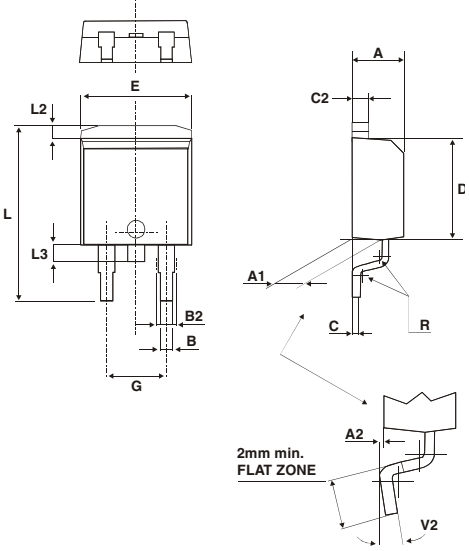
- Epoxy meets UL94, V0
- Recommended torque 0.4 to 0.6 Nm

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Table 6. TO-220AB and TO-220AB Ins dimensions

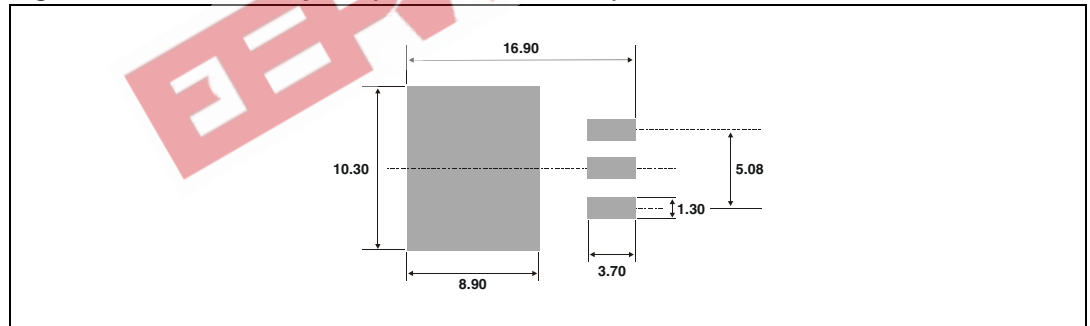
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	

Table 7. D²PAK dimensions



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.169		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.70		0.93	0.027		0.037
B2	1.25	1.40		0.048	0.055	
C	0.45		0.60	0.017		0.024
C2	1.21		1.36	0.047		0.054
D	8.95		9.35	0.352		0.368
E	10.00		10.28	0.393		0.405
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.40	0.050		0.055
L3	1.40		1.75	0.055		0.069
R		0.40			0.016	
V2	0°		8°	0°		8°

Figure 15. D²PAK footprint (dimensions in mm)



4 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
T20xxH-6T	T20xxH 6T	TO-220AB	2.3 g	50	Tube
T20xxH-6I	T20xxH 6T	TO-220AB Ins	2.3 g	50	Tube
T20xxH-6G	T20xxH 6G	D ² PAK	1.5 g	50	Tube
T20xxH-6G-TR	T20xxH 6G	D ² PAK	1.5 g	1000	Tape and reel

5 Revision history

Table 9. Document revision history

Date	Revision	Description of changes
31-May-2007	1	First issue
15-Nov-2007	2	Added TO-220AB Ins and D ² PAK packages. Reformatted to current standards.

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